Form PTO-3595 07 - 13 - 1			
6-93	11 1103+ 1120+ 5311		
To the Honorable Commissioner of Patents and Trademarks:			
Name of conveying party(ies):  MRI  6-26-98	2. Name and address of receiving party(ies):		
Cheol Soo PARK Chi Sun HWANG Chang Hun HAN	Name: Hyundai Electronics Industries Co., Ltd.  Street Address: San 136-1, Ami-ri, Bubal-eub, Ichon-		
Additional name(s) of conveying party(ies) attached? ☐ Yes X No			
3. Nature of conveyance:  X Assignment □ Merger	City: State: ZIP:		
☐ Security Agreement ☐ Change of Name ☐ Other	Additional name(s) attached?   Yes X No		
Execution Date: March 27, 1998			
4. Application or patent number(s): If this is being filed with new application  A. Patent Application No.(s)  OQ/105,274	n, the execution date of the application is: <u>March 27, 1998</u> B. Patent No.(s)		
Additional numbers at	tached? 🗆 Yes X No		
Name and address of party to whom correspondence     concerning document should be mailed:	Total number of applications and patents involved:1		
Name: Allen S. Melser	7. Total fee (37 CFR 3.41): \$_40.00		
Internal Address: REID & PRIEST LLP Street Address: 701 Pennsylvania Avenue NW	<ul> <li>☑ Enclosed</li> <li>☐ Authorized to be charged to deposit account</li> </ul>		
Suite 800	Charge deficiencies/credit overpayments to deposit account		
City: <u>Washington</u> State: <u>D.C.</u> ZIP: <u>20004</u>	8. Deposit account number:		
DO NOT USE THIS SPACE			
9. Statement and signature.  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  Allen S. Melser  Name of Person Signing  Signature  Date			
Attorney Docket No.: <u>18298.206</u> Tota	I number of pages including cover sheet, attachments and document: 2		
Do not detach this portion  7/06/1998 TSTOKES 00000031 09105274  Mail documents to be recorded with required cover sheet information to:  PC:581  Coordinates one of Patents and Trademarks, Box Assignments  Washington, D.C. 20231			

## ASSIGNMENT OF UNITED STATES APPLICATION FOR PATENT

UNFILED APPLICATION-MULTIPLE INVENTORS

Wherea have invented c	s the undersigned (1) Certain improvements in	Cheol Soo PARK, (2) Chi Sun HWANG, ar "A METHOD OF A CONTACT OF A SEMICONDUC	nd (3) <u>Chang Hun HAN</u> TOR DEVICE
application for I	Letters Patent of the Unit	ted States of America:	for which an
X was execu	ted on even date herweitl	h	
was filed of	onand was assig	gned Application No.	
of Korea and	d having an address <u>S</u> uiring an interest therein	Industries Co., Ltd., (hereinafter referred to as an 136-1, Ami-ri, Bubal-eub, Ichon-shi, K and in the Letters	_
the receipt of we unto the said Assignee, Assignee's succession, and other litigation,	which is hereby acknowled assignee, for the territory and application, and any be granted therefor toged by the Assignee for A assigns, to the full end assame would have been higher and do all lawful acts the and to obtain Letters Par Assignee's successors, and assigns, such any be known to the understand and to the understand assigns.	ration of One Dollare (\$1.00) and other good ardge, the undersigned by these presents, hereby of the United States of America, all right, title and all divisions or continuations thereof, and ther with any reissues, extensions or renewals ssignee's own use and behoof, and for Assigne of the term for which said Letters Patent may reld by the undersigned had this Assignment at tatives thereof, hereby covenant and agree to at said Assignee may consider necessary or adtent therefor, and agree at any time upon request, to communifacts relating to said invetnion and letters Patersigned and testify as to the same in any integral so all without further consideration than that is successors or assigns.	assing, sell and transfer le and interest in and to d in and to any Letters thereof, the same to be se's legal representatives, be granted, as fully and and same nto been made; execute and deliver any visable to perfect title to juest, to communicate to micate to said Assignee, tent or the interferences, terferences, opposition or
		REID & PRIEST L.L.P. to insert into this Assetent application, such as its title, filing date and	d application number.
First Inventor	Cheol Soo PARK	March 27, 199  Date	18
Thist inventor		Date	
	E. Stwang	March 27, 199	8
Second Inventor	Chi Sun HWANG	Date	
	C. H. HAN	March 27, 199	8
Third Inventor	Chang Hun HAN	Date	
Fourth Inventor		Date	· · · · · · · · · · · · · · · · · · ·

REID & PRIEST L.L.P.
701 PENNSYLVANIA AVENUE NW SUITE 800 WASHINGTON, D.C. 20004 (202) 508–4000

PATENT

RECORDED: 06/26/1998 REEL: 9295 FRAME: 0415